

L Number	Hits	Search Text	DB	Time stamp
2	1350	(257/777).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 16:54
3	2613	257/777	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 16:55
4	4196	257/778	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 17:12
5	1743	257/779	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 17:30
6	2057	257/780	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 17:45
7	1063	257/781	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 18:03
8	4196	257/778	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 18:01
9	3831	257/723	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 18:12
10	1		USPAT	2004/10/27 18:06
11	1		USPAT	2004/10/27 18:07
12	1		USPAT	2004/10/27 18:07
13	2661	257/724	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 18:30
14	1209	257/685	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 18:47
15	2825	257/686	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 19:06
16	2768	257/690	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 19:23
17	3612	(semiconductor or die or chip or Ic) with wir\$3 and solder near (ball or bump) and (encapsulat\$3 or mold\$3)	USPAT	2004/10/27 19:08
18	487	((semiconductor or die or chip or Ic) with wir\$3 and solder near (ball or bump) and (encapsulat\$3 or mold\$3)) and (ball or bump) with (big or large)	USPAT	2004/10/27 19:09

19	2749	257/700	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 20:00
20	2211	438/108	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 20:25
21	37	"5844315"	USPAT	2004/10/27 20:12
22	1		USPAT	2004/10/27 20:09
23	1		USPAT	2004/10/27 20:09
24	1		USPAT	2004/10/27 20:09
25	1		USPAT	2004/10/27 20:09
26	1		USPAT	2004/10/27 20:09
27	1		USPAT	2004/10/27 20:09
28	1		USPAT	2004/10/27 20:09
29	1		USPAT	2004/10/27 20:10
30	1		USPAT	2004/10/27 20:11
31	1		USPAT	2004/10/27 20:11
32	35	"5608265"	USPAT	2004/10/27 20:12
33	1045	438/109	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 20:42
34	3850	361/760	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/27 20:44